

(V) Preliminary Specifications () Final Specifications

Module	14.1" WXGA Color TFT-LCD with LED Backlight design
Model Name	B141EW05 V2
Note (🗭)	LED Backlight design

Customer	Date	Approved by Date
Checked & Approved by	Date	Prepared by
Note: This Specification is subj notice.	ect to change without	NBBU Marketing Division / AU Optronics corporation



Contents

1.	. Handling Precautions	4
2.	. General Description	5
	2.1 General Specification	5
	2.2 Optical Characteristics	6
3.	. Functional Block Diagram	11
4.	. Absolute Maximum Ratings	12
	4.1 Absolute Ratings of TFT LCD Module	12
	4.2 Absolute Ratings of Backlight Unit	12
	4.3 Absolute Ratings of Environment	
5.	. Electrical characteristics	13
	5.1 TFT LCD Module	13
	5.2 Backlight Unit	15
6.	. Signal Characteristic	
	6.1 Pixel Format Image	16
	6.2 The input data format	17
	6.3 Signal Description/Pin Assignment	18
	6.4 Interface Timing	22
7.	. Connector Description	24
	7.1 TFT LCD Module	24
8.	. LED Driving Specification	25
	8.1 Connector Description	25
	8.2 Pin Assignment	25
9.	. Vibration and Shock Test	26
	9.1 Vibration Test	26
	9.2 Shock Test Spec:	26
1(0. Reliability	27
1:	1. Mechanical Characteristics	28
	11.1 LCM Outline Dimension	28
	11.2 Screw Hole Depth and Center Position	30
12	2. Shipping and Package	31
	12.1 Shipping Label Format	31
	12.2 Carton package	32
	11.3 Shipping package of palletizing sequence	32
13	3. Appendix: EDID description	33



Record of Revision

Ver	sion and Date	Page	Old description	New Description	Remark
0.1	2008/5/16	All	First Edition for Customer		
0.2	2008/5/26	12	LED Light bar Driving	Update LED Light bar Driving = 25.2 (Row Output)	
0.3	2008/6/9	29,30	Update drawing	Update drawing	
0.4	2008/8/14	32	Update Label	Update Label	
0.5	2008/9/25	6		Update response time and color coodinates	
		20,28		Update drawing	
		22		Update clock frequency =70.5	
		33		Update EDID	



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1. Handling Precautions

- 1) Since front polarizer is easily damaged, pay attention not to scratch it.
- 2) Be sure to turn off power supply when inserting or disconnecting from input connector.
- 3) Wipe off water drop immediately. Long contact with water may cause discoloration or spots.
- 4) When the panel surface is soiled, wipe it with absorbent cotton or other soft cloth.
- 5) Since the panel is made of glass, it may break or crack if dropped or bumped on hard surface.
- 6) Since CMOS LSI is used in this module, take care of static electricity and insure human earth when handling.
- 7) Do not open nor modify the Module Assembly.
- 8) Do not press the reflector sheet at the back of the module to any directions.
- 9) At the insertion or removal of the Signal Interface Connector, be sure not to rotate nor tilt the Interface Connector of the TFT Module.
- 11)After installation of the TFT Module into an enclosure (Notebook PC Bezel, for example), do not twist nor bend the TFT Module even momentary. At designing the enclosure, it should be taken into consideration that no bending/twisting forces are applied to the TFT Module from outside. Otherwise the TFT Module may be damaged.
- 12) Small amount of materials having no flammability grade is used in the LCD module. The LCD module should be supplied by power complied with requirements of Limited Power Source (IEC60950 or UL1950), or be applied exemption.
- 13) Disconnecting power supply before handling LCD modules, it can prevent electric shock, DO NOT TOUCH the electrode parts, cables, connectors and LED circuit part of TFT module that a LED light bar build in as a light source of back light unit. High voltage is supplied to these parts when power turn on.



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2. General Description

B141EW05 V2 is a Color Active Matrix Liquid Crystal Display composed of a TFT LCD panel, and LED backlight system. The screen format is intended to support the WXGA (1280(H) \times 800(V)) screen and 262k colors (RGB 6-bits data driver) . All input signals are LVDS interface compatible.

B141EW05 V2 is designed for a display unit of notebook style personal computer and industrial machine.

2.1 General Specification

The following items are characteristics summary on the table at 25 $^{\circ}\mathrm{C}$ condition:

Items	Unit		Specifi	cations		
Screen Diagonal	[mm]	357.7 (14.1	W")			
Active Area	[mm]	303.36 X 189.6				
Pixels H x V		1280x3(RGB) x 800				
Pixel Pitch	[mm]	0.237				
Pixel Format		B.G.R. Ver	tical Stripe			
Display Mode		Normally W	/hite			
White Luminance (ILED=20mA) Note: ILED is LED current	[cd/m ²]	220 typ. (5 points average) 187 min. (5 points average) (Note1)				
Luminance Uniformity		1.25 max. (5 points)			
Contrast Ratio		500 typ				
Response Time	[ms]	8 typ / 12 N	1ax			
Nominal Input Voltage VDD	[Volt]	+3.3 typ.				
Power Consumption	[Watt]	4.4 max. (Ir	nclude Logic	and Blu pov	ver)	
Weight	[Grams]	385 max.				
Physical Size without inverter,	[mm]		Min.	Тур.	Max.	
bracket.		Length	319	319.5	320	
		Width 205 205.5 206				
		Thickness 4.8 - 5.5			5.5	
Electrical Interface		1 channel LVDS				
Surface Treatment		Glare,				



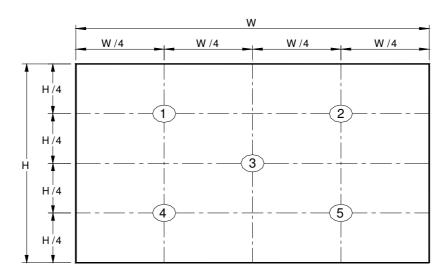
Support Color		262K colors (RGB 6-bit)
Temperature Range Operating Storage (Non-Operating) RoHS Compliance	[°C]	0 to +50 -20 to +65 RoHS Compliance

2.2 Optical Characteristics The optical characteristics are measured under stable conditions at 25 $^\circ$ C (Room Temperature) :

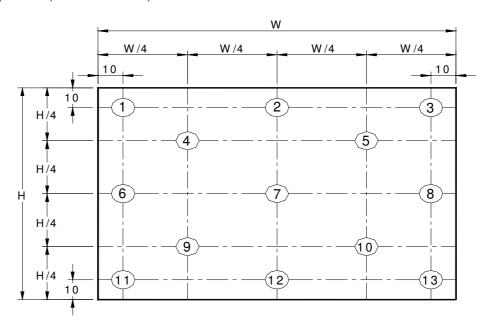
Item	Symbol	Conditions	Min.	Тур.	Max.	Unit	Note
White Luminance ILED=20mA		5 points average	187	220	-	cd/m ²	1, 4, 5.
Viewina Anale	$oldsymbol{ heta}$ R $oldsymbol{ heta}$ L	Horizontal (Righ CR = 10 (Left)	40 40	45 45	-	degree	
Viewing Angle	ф н ф ∟	Vertical (Uppe CR = 10 (Lower)) 10 30	15 35	-		4, 9
Luminance Uniformity	δ 5P	5 Points	-	-	1.25		1, 3, 4
Luminance Uniformity	δ 13P	13 Points	-	-	1.50		2, 3, 4
Contrast Ratio	CR		300	400	-		4, 6
Cross talk	%				4		4, 7
	T _r	Rising	-	6	10		
Response Time	T_f	Falling	-	2	5	msec	4, 8
	T _{RT}	Rising + Falling	-	8	12		
	Red x		0.556	0.586	0.616		
	Red y		0.316	0.346	0.376		
	Green x		0.311	0.341	0.371		
Color /	Green y		0.546	0.576	0.606		
Chromaticity	Blue x	CIE 1931	0.127	0.157	0.187		4
Coodinates	Blue y		0.090	0.120	0.150		
	White x		0.283	0.313	0.343		
	White y		0.299	0.329	0.359		
NTSC	%		-	45	-		



Note 1: 5 points position (Ref: Active area)



Note 2: 13 points position (Ref: Active area)



Note 3: The luminance uniformity of 5 or 13 points is defined by dividing the maximum luminance values by the minimum test point luminance

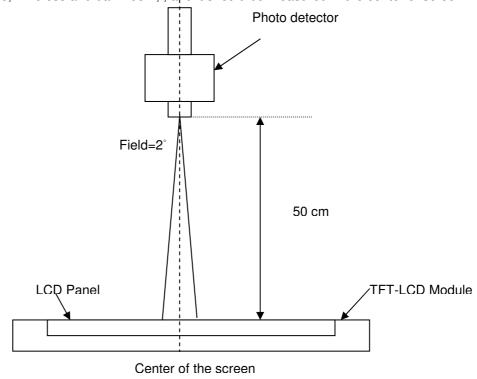
2	_	Maximum Brightness of five points
δ w5	=	Minimum Brightness of five points
2	_	Maximum Brightness of thirteen points
δ w13	=	Minimum Brightness of thirteen points

Note 4: Measurement method



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The LCD module should be stabilized at given temperature for 30 minutes to avoid abrupt temperature change during measuring. In order to stabilize the luminance, the measurement should be executed after lighting Backlight for 30 minutes in a stable, windless and dark room, , and it should be measured in the center of screen.



Note 5: Definition of Average Luminance of White (Y_L):

Measure the luminance of gray level 63 at 5 points \cdot $Y_L = [L (1) + L (2) + L (3) + L (4) + L (5)] / 5 L (x) is corresponding to the luminance of the point X at Figure in Note (1).$

Note 6: Definition of contrast ratio:

Contrast ratio is calculated with the following formula.

Note 7: Definition of Cross Talk (CT)

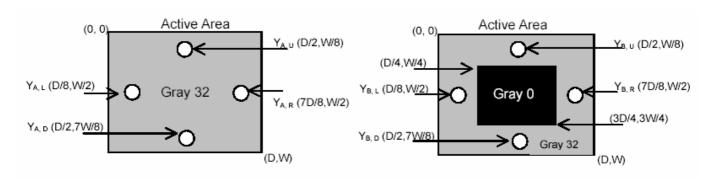
$$CT = |Y_B - Y_A| / Y_A \times 100 (\%)$$

Where

Y_A = Luminance of measured location without gray level 0 pattern (cd/m₂)

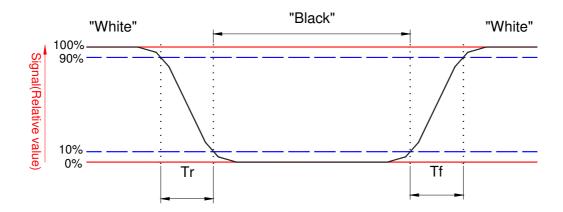
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Y_B = Luminance of measured location with gray level 0 pattern (cd/m₂)



Note 8: Definition of response time:

The output signals of BM-7 or equivalent are measured when the input signals are changed from "Black" to "White" (falling time) and from "White" to "Black" (rising time), respectively. The response time interval between the 10% and 90% of amplitudes. Refer to figure as below.

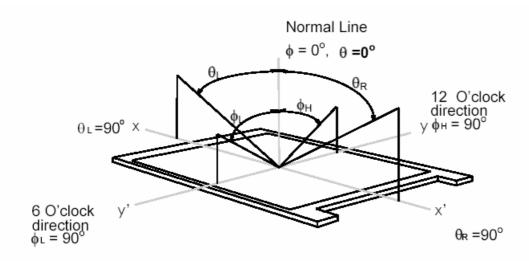




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Note 9. Definition of viewing angle

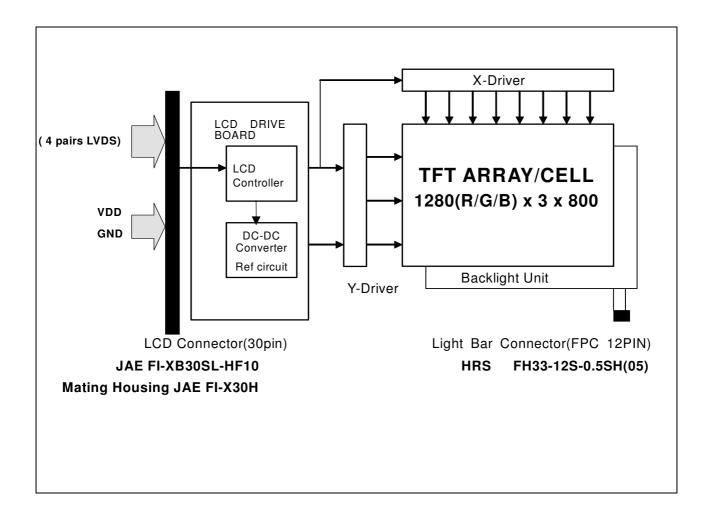
Viewing angle is the measurement of contrast ratio \geq 10, at the screen center, over a 180° horizontal and 180° vertical range (off-normal viewing angles). The 180° viewing angle range is broken down as follows; 90° (θ) horizontal left and right and 90° (Φ) vertical, high (up) and low (down). The measurement direction is typically perpendicular to the display surface with the screen rotated about its center to develop the desired measurement viewing angle.





3. Functional Block Diagram

The following diagram shows the functional block of the 14.1 inches wide Color TFT/LCD 30 Pin One ch / connector Module:





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4. Absolute Maximum Ratings

An absolute maximum rating of the module is as following:

4.1 Absolute Ratings of TFT LCD Module

Item	Symbol	Min	Max	Unit	Conditions
Logic/LCD Drive Voltage	Vin	-0.3	+4.0	[Volt]	Note 1,2

4.2 Absolute Ratings of Backlight Unit

Item	Symbol	Min	Тур	Unit	Conditions
LED Light bar Driving	V_{LED}		25.2 (Row Output)	[Volt]	Note 1,2,3
LED Light bar Driving	I _{LED}	-	20 (Row Output)	[mA] rms	Note 1,3

4.3 Absolute Ratings of Environment

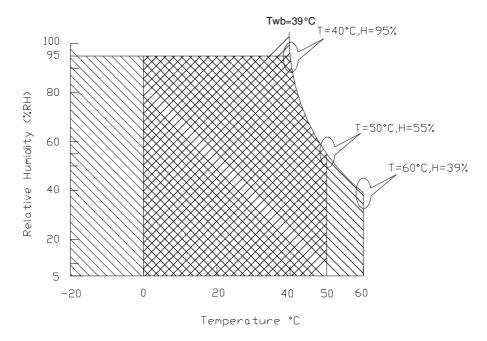
<u> </u>									
Item	Symbol	Min	Max	Unit	Conditions				
Operating Temperature	TOP	0	+50	[°C]	Note 4				
Operation Humidity	HOP	8	95	[%RH]	Note 4				
Storage Temperature	TST	-20	+65	[°C]	Note 4				
Storage Humidity	HST	5	95	[%RH]	Note 4				

Note 1: At Ta (25°C)

Note 2: ILED =20mA

Note 3: LED specification refer to section 5.2

Note 4: For quality performance, please refer to AUO IIS (Incoming Inspection Standard).



Operating Range

Storage Range





5. Electrical characteristics

5.1 TFT LCD Module

5.1.1 Power Specification

Input power specifications are as follows;

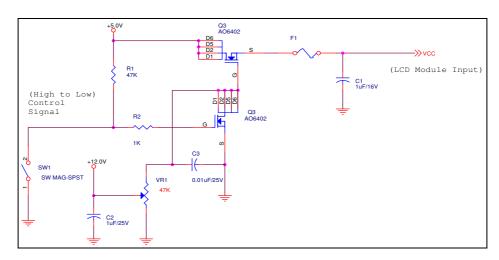
The power specification are measured under 25°C and frame frenquency under 60Hz

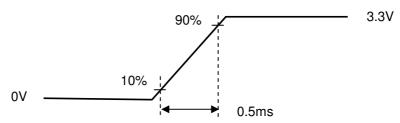
Symble	Parameter	Min	Тур	Max	Units	Note
VDD	Logic/LCD Drive Voltage	3.0	3.3	3.6	[Volt]	
PDD	VDD Power	-	-	1.1	[Watt]	Note 1/2
IDD	IDD Current	-	350	450	[mA]	Note 1/2
IRush	Inrush Current	-	-	2000	[mA]	Note 3
VDDrp	Allowable Logic/LCD Drive Ripple Voltage	-	-	100	[mV]	

Note 1: Maximum Measurement Condition: Black Pattern

Note 2: Typical Measurement Condition: Mosaic Pattern

Note 3: Measure Condition





Vin rising time



5.1.2 Signal Electrical Characteristics

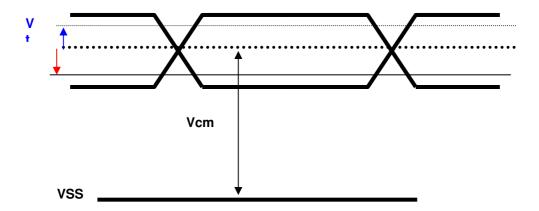
Input signals shall be low or High-impedance state when VDD is off.

It is recommended to refer the specifications of THC63LVDF84A (Thine Electronics Inc.) in detail.

Signal electrical characteristics are as follows;

Parameter	Condition	Min	Max	Unit
Vth	Differential Input High Threshold (Vcm=+1.2V)	-	100	[mV]
Vtl	Differential Input Low Threshold (Vcm=+1.2V)	-100	-	[mV]
Vcm	Differential Input Common Mode Voltage	1.125	1.375	[V]

Note: LVDS Signal Waveform





LED Parameter guideline for LED driving selection (Ref. Remark 1)

Parameter	Symbol	Min	Тур	Max	Units	Condition
LED Forward Voltage	V _F	2.95	3.15	3.35	[Volt]	(Ta=25°C)
						Note 1
LED Forward Current	I _F		20	30	[mA]	(Ta=25℃)
						Note 1
LED Life-Time	N/A	10,000	-	_	Hour	(Ta=25°C)
						(Ta=25°C) I _F =20 mA
						Note 2

Note 1: Calculator value for LED chip specification

Note 2: The LED life-time define as the estimated time to 50% degradation of initial luminous.



6. Signal Characteristic

6.1 Pixel Format Image

Following figure shows the relationship of the input signals and LCD pixel format.

	1						128	30
1st Line	R G B	B G R		R	G	В	R (В
		1	1					
		•	T.		•			
	•	,	•					
	•	•	·		•			
800th Line	R G B	R G B		R	G	В	R	В



6.2 The input data format

RxCLKIN		
RxIN0	G0 R5 R4 R3 R2	R1 R0
RxIN1	B1 B0 G5 G4 G3	G2 G1 X
RxIN2	DE VS HS B5 B4	B3 B2

Cianal Nama	Description	
Signal Name	Description (MCD)	Dad shall Date
R5	Red Data 5 (MSB)	Red-pixel Data
R4	Red Data 4	Each red pixel's brightness data consists of
R3	Red Data 3	these 6 bits pixel data.
R2	Red Data 2	
R1	Red Data 1	
R0	Red Data 0 (LSB)	
	Red-pixel Data	
	·	
G5	Green Data 5 (MSB)	Green-pixel Data
G4	Green Data 4	Each green pixel's brightness data consists of
G3	Green Data 3	these 6 bits pixel data.
G2	Green Data 2	
G1	Green Data 1	
G0	Green Data 0 (LSB)	
D -	Green-pixel Data	5
B5	Blue Data 5 (MSB)	Blue-pixel Data
B4	Blue Data 4	Each blue pixel's brightness data consists of
B3	Blue Data 3	these 6 bits pixel data.
B2	Blue Data 2	
B1	Blue Data 1	
B0	Blue Data 0 (LSB)	
	Blue-pixel Data	
RxCLKIN	Data Clock	The signal is used to strobe the pixel data and
IIAOLININ	Data Ciuck	DE signals. All pixel data shall be valid at the
DE	Dioplay Timing	falling edge when the DE signal is high.
DE	Display Timing	This signal is strobed at the falling edge of
		RxCLKIN. When the signal is high, the pixel
VC	Vartical Cura	data shall be valid to be displayed.
VS	Vertical Sync	The signal is synchronized to RxCLKIN.
HS	Horizontal Sync	The signal is synchronized to RxCLKIN.

Note: Output signals from any system shall be low or High-impedance state when VDD is off.



6.3 Signal Description/Pin Assignment

LVDS is a differential signal technology for LCD interface and high speed data transfer device.

PIN#	Symbol	Function
1	GND	Ground
2	VDD	+3.3V Power Supply
3	VDD	+3.3V Power Supply
4	VEDID	+3.3V EDID Power
5	NC	No Connection (Reserve for AUO test)
6	CLKEDID	EDID Clock Input
7	DATAEDID	EDID Data Input
8	RxIN0-	-LVDS differential data input (R0-R5, G0)
9	RxIN0+	+LVDS differential data input (R0-R5, G0)
10	GND	Ground
11	RxIN1-	-LVDS differential data input(G1-G5, B0-B1)
12	RxIN1+	+LVDS differential data input(G1-G5, B0-B1)
13	GND	Ground
14	RxIN2-	-LVDS differential data input(B2-B5, HS, VS, DE)
15	RxIN2+	+LVDS differential data input(B2-B5, HS, VS, DE)

B141EW05 V2 Document Version: 0.5 18 of 35

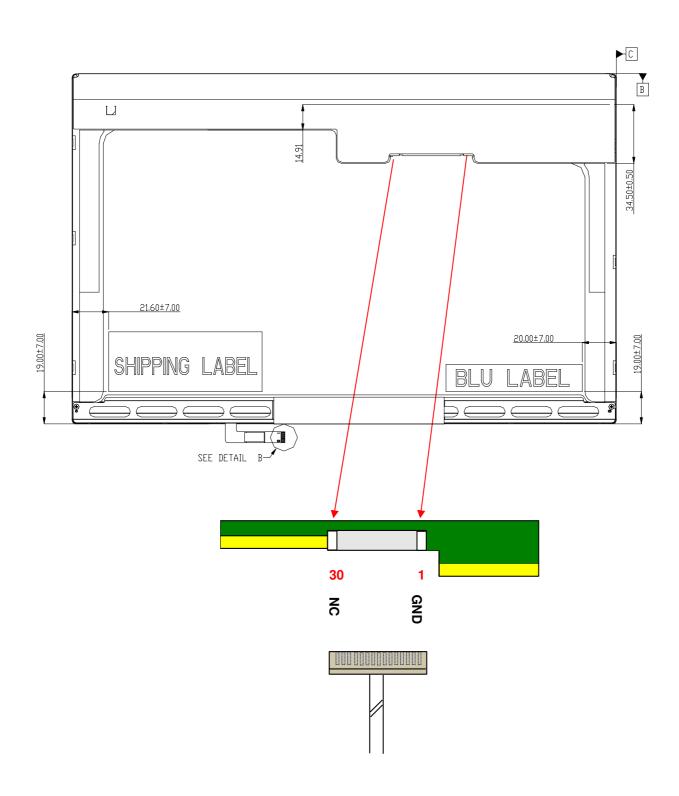


PIN#	Symbol	Function
16	GND	Ground
17	RxCLKIN-	-LVDS differential clock input
18	RxCLKIN+	+LVDS differential clock input
19	GND	Ground
20	NC	No Connection
21	NC	No Connection)
22	GND	Ground
23	NC	No Connection
24	NC	No Connection
25	GND	Ground
26	NC	No Connection
27	NC	No Connection
28	GND	Ground
29	NC	No Connection
30	NC	No Connection

19 of 35

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Note1: Start from right side



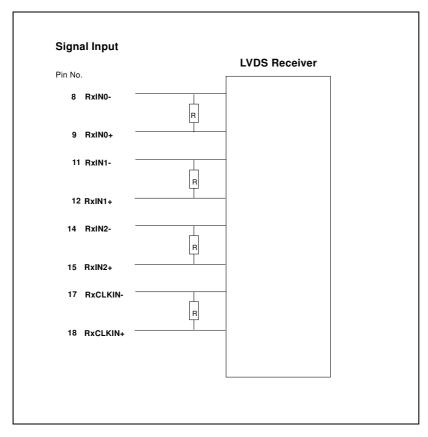
Note2: Input signals shall be low or High-impedance state when VDD is off.



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internal circuit of LVDS inputs are as following.

The module uses a 100ohm resistor between positive and negative data lines of each receiver input





6.4 Interface Timing

6.4.1 Timing Characteristics

Basically, interface timings should match the 1280x800 /60Hz manufacturing guide line timing.

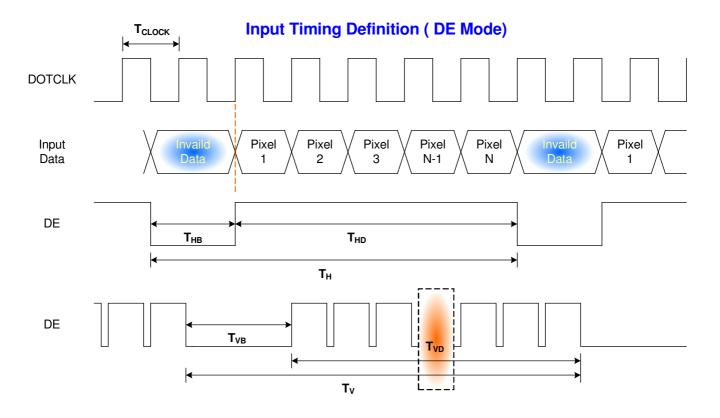
Parameter		Symbol	Min.	Тур.	Max.	Unit
Frame Rate		-	-	60	-	Hz
Clock fr	equency	1/ T _{Clock}	•	71.1	•	MHz
	Period	T_V	808	823	1023	
Vertical	Active	T _{VD}	800	800	800	T_Line
Section	Blanking	T _{VB}	8	23	223	
	Period	T _H	1310	1438	2047	
Horizontal Section	Active	T _{HD}	1280	1280	1280	T_{Clock}
	Blanking	T _{HB}	30	158	767	

Note: DE mode only

22 of 35



6.4.2 Timing diagram





7. Connector Description

Physical interface is described as for the connector on module.

These connectors are capable of accommodating the following signals and will be following components.

7.1 TFT LCD Module

Connector Name / Designation	For Signal Connector
Manufacturer	JAE or compatible
Type / Part Number	JAE FI-XB30SL-HF10 or compatible
Mating Housing/Part Number	JAE FI-X30H or compatible



8. LED Driving Specification

8.1 Connector Description

Connector Name / Designation	For Signal Connector		
Manufacturer	HRS or compatible		
Type / Part Number	HRS FH33-12S-0. 5SH(05) or compatible		
Mating Housing/Part Number	compatible		

8.2 Pin Assignment

PIN#	Signal Name Description
1	LCD channel 1 cathode
2	LCD channel 2 cathode
3	LCD channel 3 cathode
4	LCD channel 4 cathode
5	LCD channel 5 cathode
6	LCD channel 6 cathode (May be NC if channel<6)
7	LCD channel 7 cathode (May be NC if channel<7)
8	LCD channel 8 cathode (May be NC if channel<8)
9	NC
10	LED power bus (LED Anode)
11	LED power bus (LED Anode)
12	LED power bus (LED Anode)

5 25 of 35 B141EW05 V2 Document Version: 0.5



9. Vibration and Shock Test

9.1 Vibration Test

Test Spec:

Test method: Non-Operation

Acceleration: 1.5 G, Half sine pulse Frequency: 10 - 500Hz Sine wave

Sweep: 30 Minutes each Axis (X, Y, Z)

9.2 Shock Test Spec:

Test Spec:

Test method: Non-Operation

Acceleration: 240 G, Half sine pulse

Active time: 2 ms

Pulse: X,Y,Z .one time for each side



10. Reliability

Items	Required Condition	Note
Temperature Humidity Bias	Ta= 40℃, 90%RH, 300h	
High Temperature Operation	Ta= 50℃, Dry, 300h	
Low Temperature Operation	Ta= 0℃, 300h	
High Temperature Storage	Ta= 60℃, 300h	
Low Temperature Storage	Ta= -20℃, 300h	
Thermal Shock Test	Ta=-20℃to 60℃, Duration at 30 min, 100 cycles	
ESD	Contact : ±8 KV	Note 1
230	Air: ±15 KV	

Note1: According to EN 61000-4-2, ESD class B: Some performance degradation allowed. No data lost

. Self-recoverable. No hardware failures.

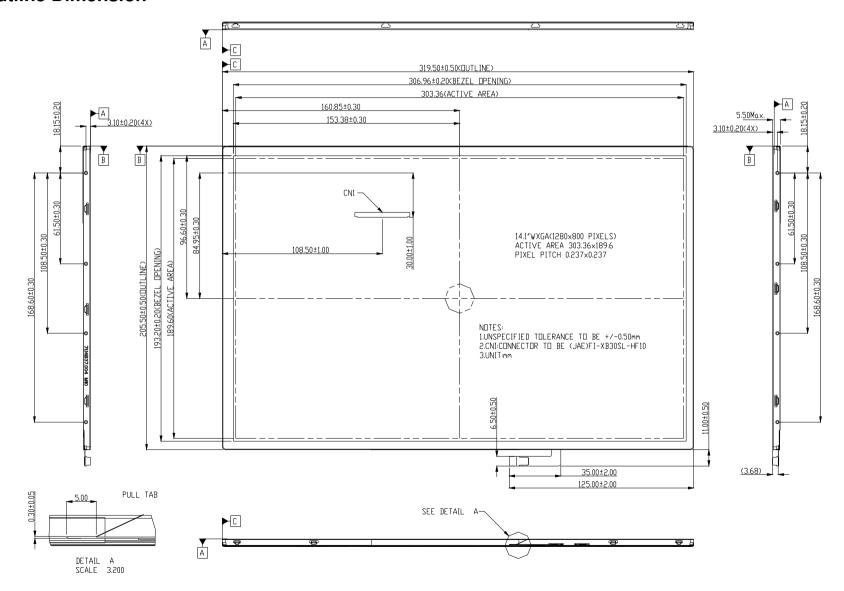
Remark: MTBF (Excluding the LED): 30,000 hours with a confidence level 90%



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11. Mechanical Characteristics

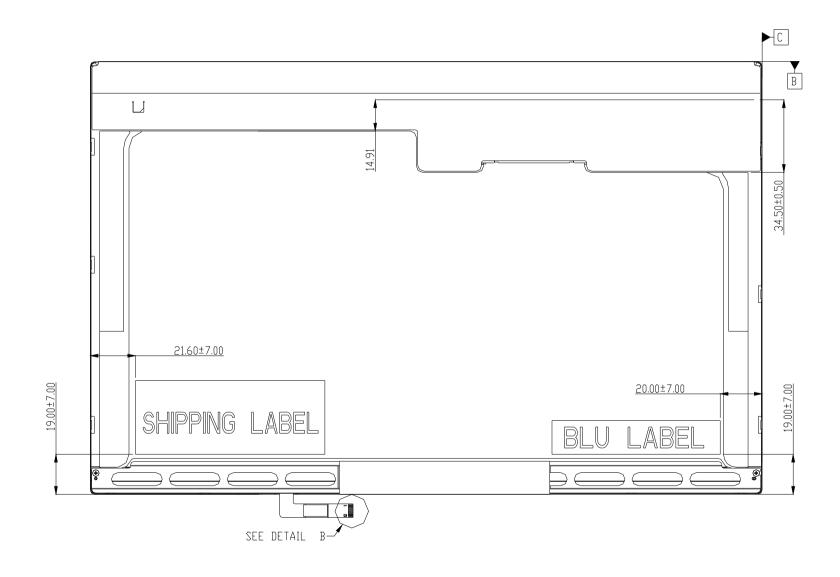
11.1 LCM Outline Dimension

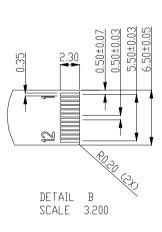


B141EW05 V2 Document Version: 0.5 28 of 35



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B141EW05 V2 Document Version: 0.5

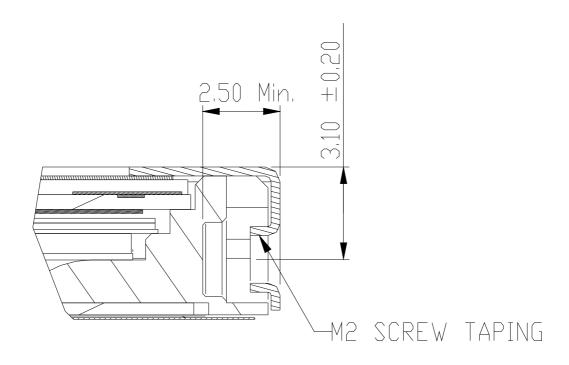


11.2 Screw Hole Depth and Center Position

Screw hole minimum depth, from side surface = 2.5 mm (See drawing)

Screw hole center location, from front surface = 3.1 ± 0.2 mm (See drawing)

Screw Torque: Maximum 2.5 kgf-cm





12. Shipping and Package

12.1 Shipping Label Format



Manufactured 0938

V.2 Model No: B141EW05 1AXXG **AU Optronics**

MADE IN CHINA (S1)

H/W: 1A F/W:1

 \mathbf{z} u \mathbf{R}



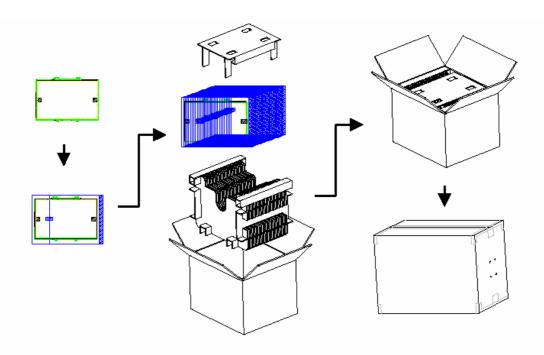




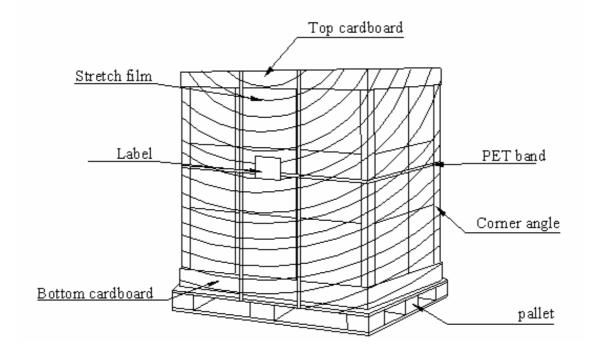


12.2 Carton package

The outside dimension of carton is 455 (L)mm x 380 (W)mm x 355 (H)mm



11.3 Shipping package of palletizing sequence





13. Appendix: EDID description

Address	FUNCTION	Value	Value	Value	Note
HEX		HEX	BIN	DEC	
00	Header	00	00000000	0	
01		FF	11111111	255	
02		FF	11111111	255	
03		FF	11111111	255	
04		FF	11111111	255	
05		FF	11111111	255	
06		FF	11111111	255	
07		00	00000000	0	
08	EISA Manuf. Code LSB	06	00000110	6	
09	Compressed ASCII	AF	10101111	175	
0A	Product Code	44	01000100	68	
0B	hex, LSB first	52	01010010	82	
0C	32-bit ser #	00	00000000	0	
0D	02 81000. 11	00	00000000	0	
0E		00	00000000	0	
0F		00	00000000	0	
10	Week of manufacture	01	00000001	1	
11	Year of manufacture	12	00010010	18	
12	EDID Structure Ver.	01	00000001	1	
13	EDID revision #	03	00000011	3	
14	Video input def. (digital I/P, non-TMDS, CRGB)	80	10000000	128	
15	Max H image size (rounded to cm)	1E	00011110	30	
16	Max V image size (rounded to cm)	13	00011110	19	
17	Display Gamma (=(gamma*100)-100)	78	01111000	120	
18	Feature support (no DPMS, Active OFF, RGB, tmg Blk#1)	0A	00001010	10	
19	Red/green low bits (Lower 2:2:2:2 bits)	26	00100110	38	
1A	Blue/white low bits (Lower 2:2:2:2 bits)	75	01110101	117	
1B	Red x (Upper 8 bits)	96	10010110	150	
1C	Red y/ highER 8 bits	58	01011000	88	
1D	Green x	57	01011100	87	
1E	Green y	93	10010011	147	
1F	Blue x	28	00101000	40	
20	Blue y	1E	00011110	30	†
21	White x	50	01010000	80	
22	White y	54	01010000	84	
23	Established timing 1	00	00000000	0	
24	Established timing 1 Established timing 2	00	00000000	0	
25	Established timing 3	00	00000000	0	
26	Standard timing #1	01	00000001	1	
27	Standard tilling #1	01	00000001	1	
28	Standard timing #2	01	00000001	1	
29	Standard timing #2	01	00000001	1	
2A	Standard timing #3	01	00000001	1	†
2B	Standard tilling #5	01	00000001	1	
2C	Standard timing #4	01	00000001	1	1
2D	Standard tilling #4	01	00000001	1	+
2E	Standard timing #5	01	00000001	1	+
2F	Standard tilling #5	01	00000001	1	
30	Standard timing #6	01	00000001	1	
31	Standard liftling #6	01		1	+
31	Standard timing #7	01	00000001	1	1
33	Standard timing #7		00000001		1
აა		01 01	00000001	1	

B141EW05 V2 Document Version: 0.5 33 of 35



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35		01	00000001	1	
36	Pixel Clock/10000 LSB	C6	11000110	198	
37	Pixel Clock/10000 USB	1B	00011011	27	
38	Horz active Lower 8bits	00	00000000	0	
39	Horz blanking Lower 8bits	9E	10011110	158	
3A	HorzAct:HorzBlnk Upper 4:4 bits	50	01010000	80	
3B	Vertical Active Lower 8bits	20	00100000	32	
3C	Vertical Blanking Lower 8bits	17	00010111	23	
3D	Vert Act : Vertical Blanking (upper 4:4 bit)	30	00110000	48	
3E	HorzSync. Offset	30	00110000	48	
3F	HorzSync.Width	20	00100000	32	
40	VertSync.Offset : VertSync.Width	36	00110110	54	
41	Horz‖ Sync Offset/Width Upper 2bits	00	00000000	0	
42	Horizontal Image Size Lower 8bits	2F	00101111	47	
43	Vertical Image Size Lower 8bits	BD	10111101	189	
44	Horizontal & Vertical Image Size (upper 4:4 bits)	10	00010000	16	
45	Horizontal Border (zero for internal LCD)	00	00000000	0	
46	Vertical Border (zero for internal LCD)	00	00000000	0	
47	Signal (non-intr, norm, no stero, sep sync, neg pol)	18	00011000	24	
48	Detailed timing/monitor	00	00000000	0	
49	descriptor #2	00	00000000	0	
4A		00	00000000	0	
4B		0F	00001111	15	
4C		00	00000000	0	
4D		00	00000000	0	
4E 4F		00	00000000	0	
50		00	00000000	0	
51		00	00000000	0	
52		00	00000000	0	
53		00	00000000	0	
54		00	00000000	0	
55		00	00000000	0	
56		00	00000000	0	
57		00	00000000	0	
58		00	00000000	0	
59		20	00100000	32	
5A	Detailed timing/monitor	00	00000000	0	
5B	descriptor #3	00	00000000	0	
5C		00	00000000	0	
5D		FE	11111110	254	
5E		00	00000000	0	
5F	Manufacture	41	01000001	65	Α
60	Manufacture	55	01010101	85	U
61	Manufacture	4F	01001111	79	0
62		0A	00001010	10	
63		20	00100000	32	
64		20	00100000	32	
65		20	00100000	32	
66		20	00100000	32	
67		20	00100000	32	
68		20	00100000	32	
69		20	00100000	32	
6A		20	00100000	32	
6B 6C	Datailed timing/manitor	20 00	00100000 00000000	32	
6D	Detailed timing/monitor descriptor #4	00	00000000	0	
6E	descriptor #4	00	00000000	0	
6F		FE	11111110	254	
	1	1-6	11111110	204	



70		00	00000000	0	
71	Manufacture P/N	42	01000010	66	В
72	Manufacture P/N	31	00110001	49	1
73	Manufacture P/N	34	00110100	52	4
74	Manufacture P/N	31	00110001	49	1
75	Manufacture P/N	45	01000101	69	Е
76	Manufacture P/N	57	01010111	87	W
77	Manufacture P/N	30	00110000	48	0
78	Manufacture P/N	35	00110101	53	5
79	Manufacture P/N	20	00100000	32	
7A	Manufacture P/N	56	01010110	86	V
7B	Manufacture P/N	32	00110010	50	2
7C		20	00100000	32	
7D		0A	00001010	10	
7E	Extension Flag	00	00000000	0	
7F	Checksum	4F	01001111	79	
			SUM	5888	

SUM to HEX 1700